

# **SCT4050KE**

**N-channel SiC power MOSFET** 

V <sub>DSS</sub>	1200V
R <sub>DS(on)</sub> (Typ.)	50mΩ
$I_{D}^{*1}$	32A
P <sub>D</sub>	136W

#### Outline



Inner circuit

## Features

- 1) Low on-resistance
- 2) Fast switching speed
- 3) Fast reverse recovery
- 4) Easy to parallel
- 5) Simple to drive
- 6) Pb-free lead plating ; RoHS compliant

### Application

- · Solar inverters
- DC/DC converters
- · Switch mode power supplies
- Induction heating
- Motor drives

	(3)0		
●Packa	ging specifications		
	Packing	Tube	
	Reel size (mm)	-	

(1) Gate (2) Drain

(3) Source \*1 Body Diode

 $(1)^{(2)(3)}$ 

(2)q

	Packing	Tube
	Reel size (mm)	-
Typo	Tape width (mm)	-
Туре	Basic ordering unit (pcs)	30
	Taping code	C11
	Marking	SCT4050KE

### ●Absolute maximum ratings (T<sub>vj</sub> = 25°C unless otherwise specified)

Parameter			Symbol	Value	Unit
Drain - source voltage		V <sub>DSS</sub>	1200	V	
Continuous drain	V - V	$T_c = 25^{\circ}C$	<b>1 1 *</b> 1	32	А
and source current	nd source current $V_{GS} = V_{GS_on} = 100^{\circ} C$ $I_D, I_S^{*1}$	I <sub>D</sub> , I <sub>S</sub>	22	А	
Pulsed drain current	$V_{GS} = V_{GS_{on}}$	$T_c = 25^{\circ}C$	I <sub>D,pulse</sub> *2	73	А
Body diode pulsed forward current $T_c = 25^{\circ}C$		<sup>*1,*3</sup> S,pulse	32	А	
Body diode surge forward current $V_{GS} = 0 V$		$V_{GS} = 0 V$	*1,*4 I <sub>S,pulse</sub>	73	А
Gate - source voltage (DC)		$V_{GSS_{DC}}$	-4 to +21	V	
Gate - source surge volt	age (t <sub>surge</sub> < 300	)ns)	$V_{GSS\_surge}$ *5	-4 to +23	V
Recommended turn-on gate - source drive voltage		V <sub>GS_on</sub> *6	+15 to +18	V	
Recommended turn-off gate - source drive voltage		$V_{GS_{off}}$	0	V	
Virtual junction temperature		T <sub>vj</sub>	175	°C	
Range of storage temperature		T <sub>stg</sub>	-40 to +175	°C	

# •Electrical characteristics ( $T_{vj} = 25^{\circ}C$ unless otherwise specified)

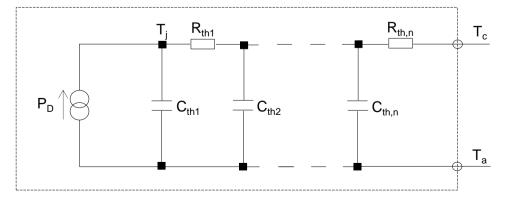
Deremeter	Cumphal	Conditions		Linit		
Parameter	Symbol	Conditions	Min.	Тур.	Max.	Unit
Drain - Source breakdown	V	$V_{GS} = 0 V, I_D = 7mA$				V
voltage	V <sub>(BR)DSS</sub>	T <sub>vj</sub> = 25°C	1200	-	-	v
		$V_{GS} = 0 V, V_{DS} = 1200V$				
Zero Gate voltage Drain current	$I_{DSS}$	T <sub>vj</sub> = 25°C	-	1	80	μA
		T <sub>vj</sub> = 150°C	-	10	-	
Gate - Source leakage current	I <sub>GSS+</sub>	$V_{GS} = +21V$ , $V_{DS} = 0V$	-	-	100	nA
Gate - Source leakage current		$V_{GS} = -4V$ , $V_{DS} = 0V$	-	-	-100	nA
Gate threshold voltage	$V_{GS(th)}  {}^{*7}$	$V_{DS} = 10V, I_D = 8mA$	2.8	-	4.8	V
		$V_{GS} = 18V, I_{D} = 15A$				
Static Drain - Source on - state resistance	${\sf R}_{\sf DS(on)}$ *8	T <sub>vj</sub> = 25°C	-	50	65	mΩ
		T <sub>vj</sub> = 150°C	-	100	-	
Gate input resistance	$R_G$	f = 1MHz, open drain	-	5	-	Ω

#### •Thermal resistance

Paramotor	Symbol	Values			Unit
Parameter		Min.	Тур.	Max.	Offic
Thermal resistance, junction - case	${\sf R_{thJC}}^{*9}$	-	0.82	1.1	K/W

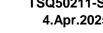
#### •Typical Transient Thermal Characteristics

Symbol	Value	Unit	Symbol	Value	Unit
R <sub>th1</sub>	1.1 ×10 <sup>-1</sup>		C <sub>th1</sub>	9.1 ×10 <sup>-4</sup>	
R <sub>th2</sub>	3.9 ×10 <sup>-1</sup>	K/W	C <sub>th2</sub>	4.2 ×10 <sup>-3</sup>	Ws/K
R <sub>th3</sub>	3.5 ×10 <sup>-1</sup>		C <sub>th3</sub>	8.0 ×10 <sup>-2</sup>	



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# •Electrical characteristics ( $T_{vj}$ = 25°C unless otherwise specified)

	O and al	mbol Conditions		Values		
Parameter	Symbol	Conditions	Min.	Тур.	Max.	Unit
Transconductance	<b>g</b> <sub>fs</sub> *8	$V_{DS} = 10V, I_{D} = 15A$	-	7.4	-	S
Input capacitance	C <sub>iss</sub>	$V_{GS} = 0V$	-	1703	-	
Output capacitance	C <sub>oss</sub>	V <sub>DS</sub> = 800V	-	59	-	pF
Reverse transfer capacitance	C <sub>rss</sub>	f = 1MHz	-	4	-	
Effective output capacitance, energy related	C <sub>o(er)</sub>	$V_{GS} = 0V$ $V_{DS} = 0V$ to 800V	-	70	-	pF
Total Gate charge	Q <sub>g</sub> *8	$V_{DS} = 800V$ $I_{D} = 15A$	-	71	-	
Gate - Source charge	Q <sub>gs</sub> *8	$V_{GS} = 18V$	-	16	-	nC
Gate - Drain charge	Q <sub>gd</sub> *8	See Fig. 1-1, 1-2.	-	23	-	
Turn - on delay time	t <sub>d(on)</sub> *8	V <sub>DS</sub> = 800V I <sub>D</sub> = 15A	-	11	-	
Rise time	t <sub>r</sub> *8	V <sub>GS</sub> = +18V / 0V	-	19	-	ns
Turn - off delay time	t <sub>d(off)</sub> *8	$R_G = 0\Omega, L = 250\mu H$ E <sub>on</sub> includes diode	-	31	-	115
Fall time	t <sub>f</sub> *8	reverse recovery $L_{\sigma} = 50$ nH, $C_{\sigma} = 10$ pF	-	14	-	
Turn - on switching loss	E <sub>on</sub> *8	See Fig. 2-1, 2-2, 2-3.	-	550	-	μJ
Turn - off switching loss	E <sub>off</sub> *8		-	6	-	μυ
Short-circuit $V_{GS(on)} = +15V$	t <sub>sc</sub> *10	V <sub>DS</sub> ≤ 800V V <sub>DS,peak</sub> ≤ 1200V	-	4.5	-	μs
withstand time $V_{GS(on)} = +18V$		$T_{vj(start)} = 25^{\circ}C$ $R_{G} = 2.2\Omega$	-	4.0	-	μs



#### •Body diode electrical characteristics (Source-Drain) (T<sub>vi</sub> = 25°C unless otherwise specified)

Parameter	Symbol	Conditions	Values			Unit
Parameter	Symbol	Conditions	Min.	Тур.	Max.	Unit
Forward voltage	$V_{SD}^{*8}$	$V_{GS} = 0V, I_S = 15A$	-	3.3	-	V
Reverse recovery time	t <sub>rr</sub> *8	I <sub>F</sub> = 15A V <sub>R</sub> = 800V	-	12	-	ns
Reverse recovery charge	Q <sub>rr</sub> *8	di/dt = 2700A/μs	-	95	-	nC
Peak reverse recovery current	I <sub>rrm</sub> *8	$L_{\sigma} = 50$ nH, $C_{\sigma} = 10$ pF See Fig. 3-1, 3-2.	-	12	-	А

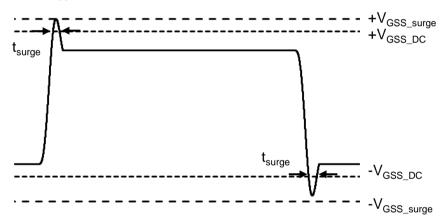
\*1 Limited by maximum  $T_{vi}$  and for Max.  $R_{thJC}$ .

\*2 Pulse width and duty cycle are limited by  $T_{vj,max}$ .

\*3 Only for body-diode, Repetitive pulse, PW  $\leq$  1.5µs, Duty cycle  $\leq$  5%

\*4 When used as a protective function, PW  $\leq$  10µs

\*5 Example of acceptable V<sub>GS</sub> waveform



- \*6 Please be advised not to use SiC-MOSFETs with V<sub>GS</sub> below 10V as doing so may cause thermal runaway.
- \*7 Tested after applying  $V_{GS}$  = 21V for 100ms.

#### \*8 Pulsed

\*9 Measured conformable to JESD51-14.

See the application note "rthjc\_measurement\_and\_usage\_an-e.pdf". Link

 ${\tt URL: https://fscdn.rohm.com/en/products/databook/applinote/discrete/common/rthjc\_measurement\_and\_usage\_an-e.pdf}$ 

\*10 Single pulsed.



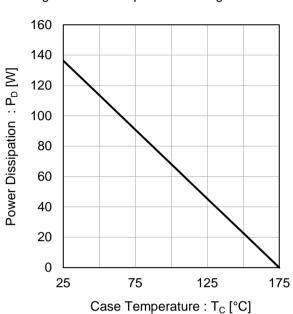
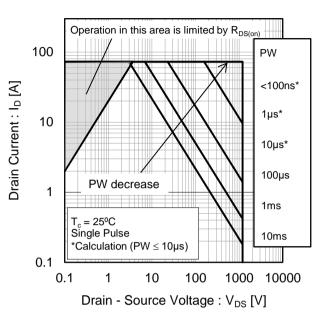
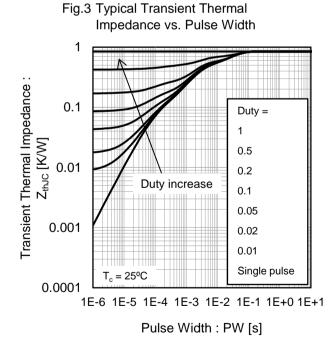


Fig.1 Power Dissipation Derating Curve

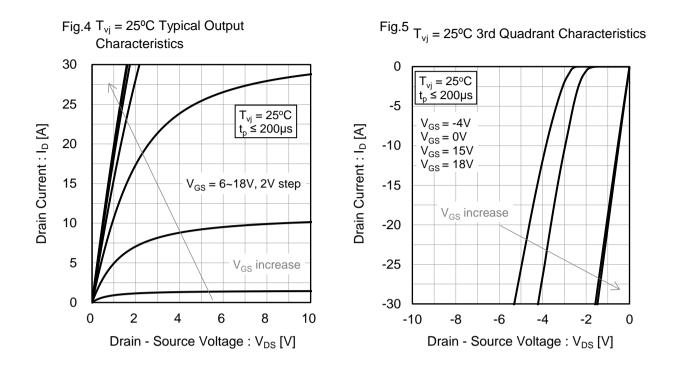
Fig.2 Maximum Safe Operating Area



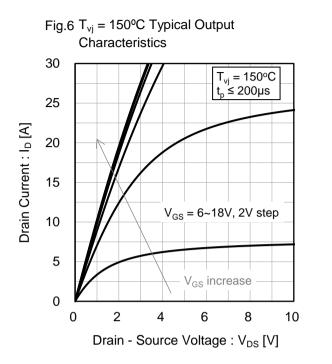


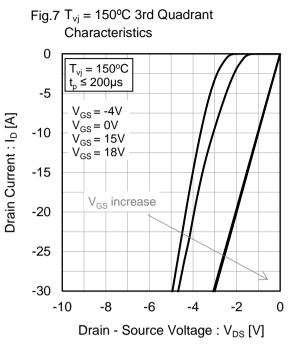
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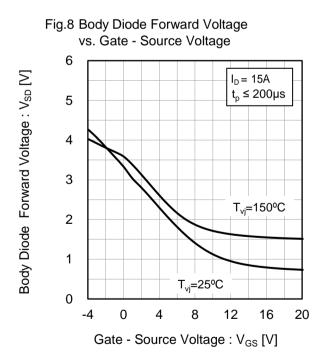














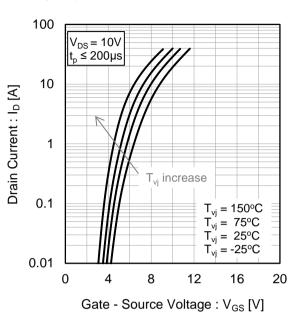
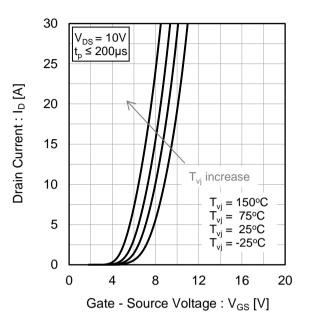


Fig.9 Typical Transfer Characteristics (I)

Fig.10 Typical Transfer Characteristics (II)



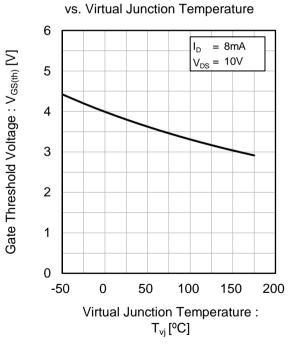


Fig.12 Transconductance vs. Drain Current

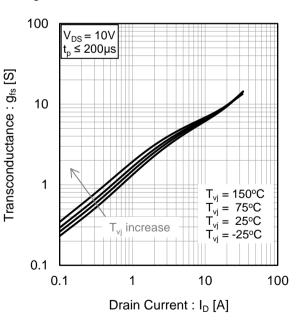
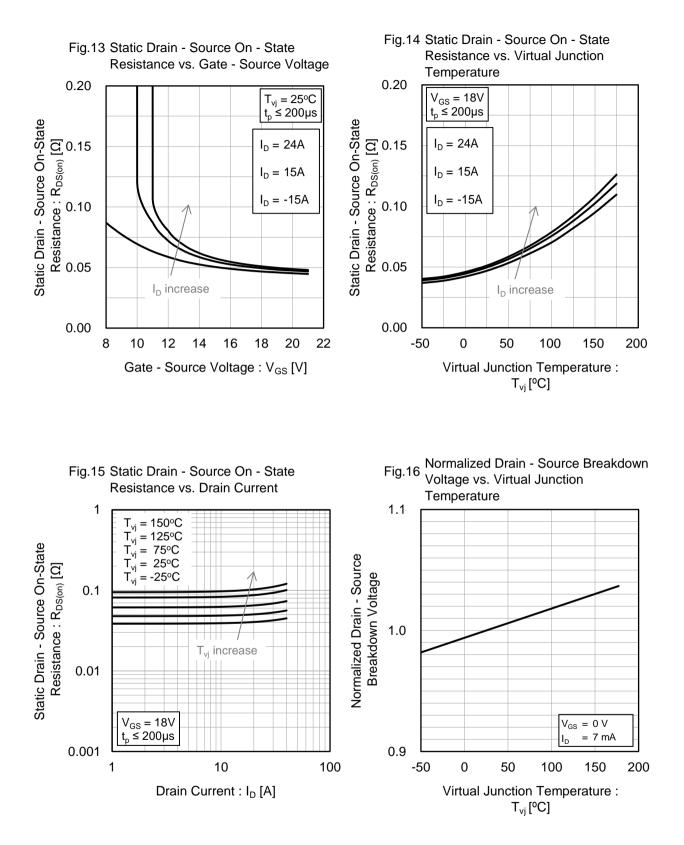
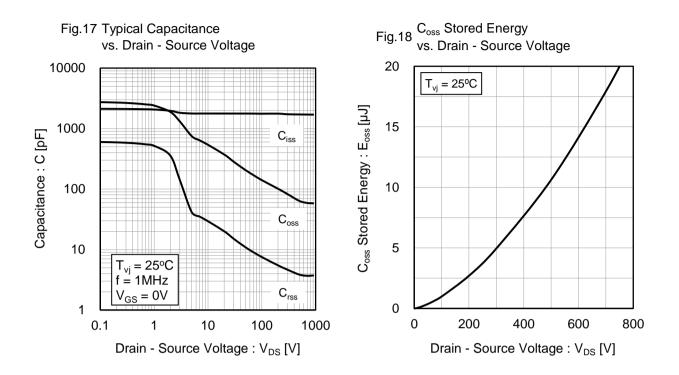


Fig.11 Gate Threshold Voltage

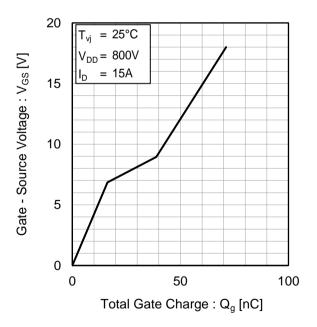




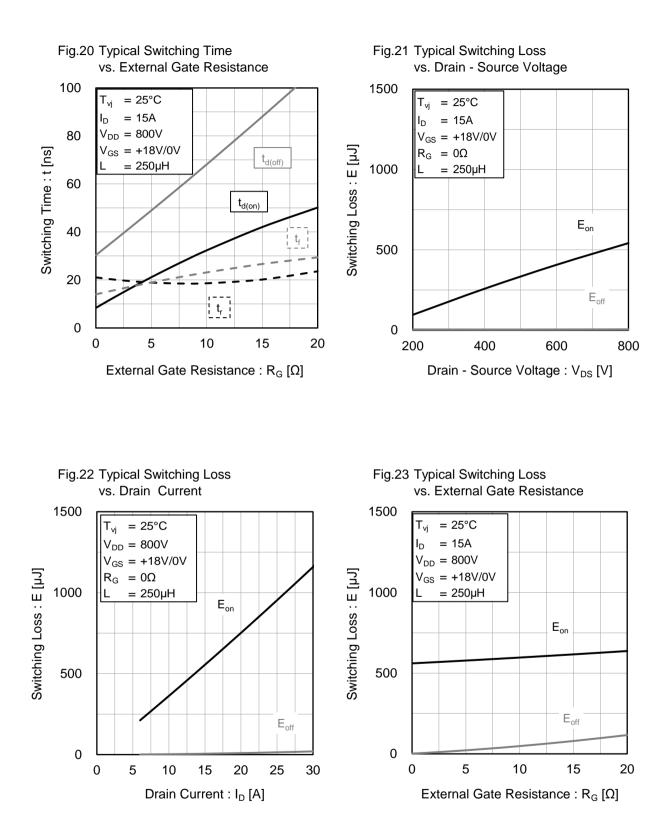




#### Fig.19 Dynamic Input Characteristics











#### Measurement circuits and waveforms

Fig.1-1 Gate Charge Measurement Circuit

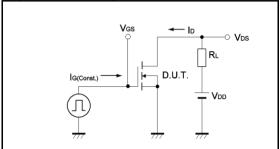
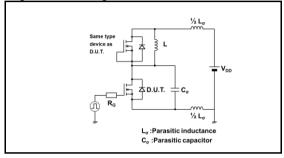


Fig.2-1 Switching Characteristics Measurement Circuit



#### Fig.2-3 Waveforms for Switching Energy Loss

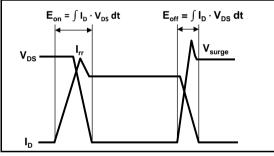
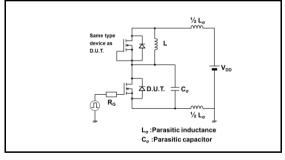
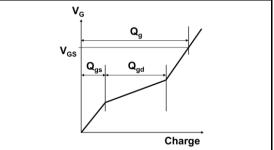


Fig.3-1 Reverse Recovery Time Measurement Circuit



# Fig.1-2 Gate Charge Waveform





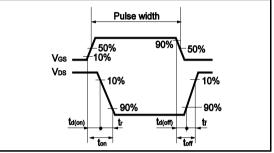
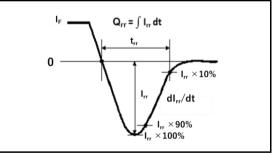


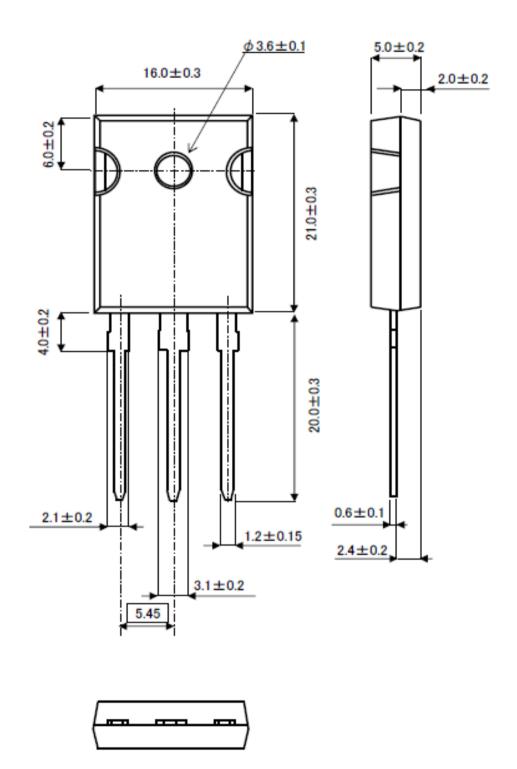
Fig.3-2 Reverse Recovery Waveform





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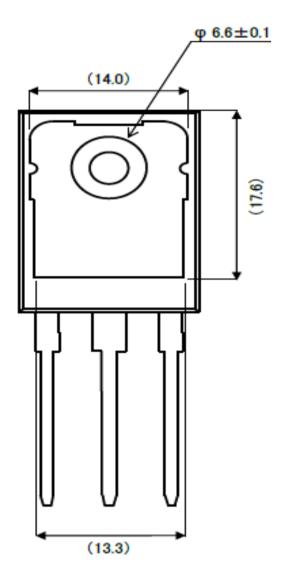
#### • Package Dimensions



Unit: mm







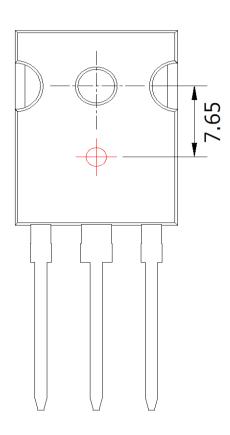
Unit: mm





#### Die Bonding Layout





•Front view of the packaging.

•Dimensions are design values.

·If the heat sink is to be installed, it should be in contact with the die bonding point.

Unit: mm





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